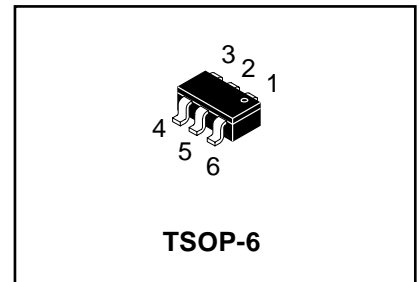


4-CHANNEL LOW CAPACITANCE ESD PROTECTION DIODES ARRAY

DESCRIPTIONS

The LRC099MC-04AT1G is a 4-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail. A zener diode is integrated in to the array between the positive and negative supply rails. In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage. The LRC099MC-04AT1G is idea to protect high speed data lines. Three package type is provided for easy PCB layout.

LRC099MC-04AT1G



FEATURES

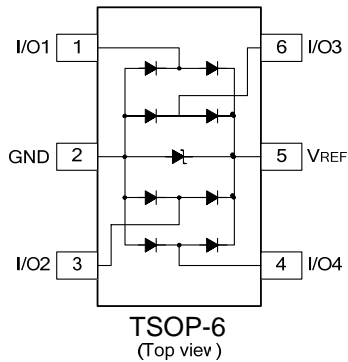
- * 4 channels of ESD protection;
- * Provides ESD protection to IEC61000-4-2 level 4
 - ±15kV air discharge
 - ±8kV contact discharge;
- * Channel I/O to GND capacitance: 1.5pF(Max)
- * Channel I/O to I/O capacitance: 1.0pF(Max)
- * Low clamping voltage;
- * Low operating voltage;
- * Improved zener structure;
- * Optimized package for easy high speed data lines PCB layout;
- * RoHS compliant.

APPLICATIONS

- * HDMI / DVI ports;
- * Display Port interface;
- * 10M / 100M / 1G Ethernet;
- * USB 2.0 interface;
- * VGA interface
- * Set-top box;
- * Flat panel Monitors / TVs;
- * PC / Note book

ORDERING INFORMATION

Part No.	Package	Marking	Material	Shipping
LRC099MC-04AT1G	TSOP-6	C98	Halogen Free	3000Tape&Reel

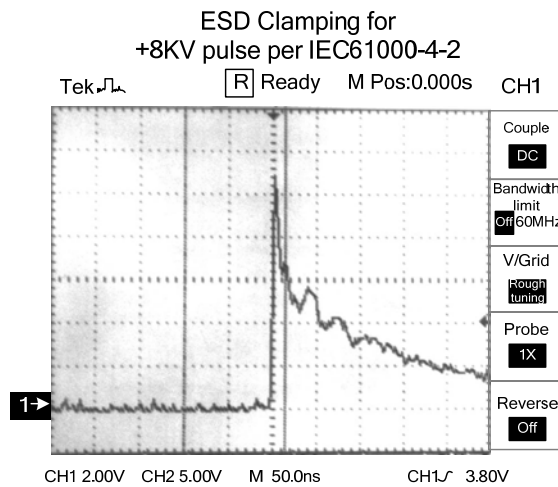
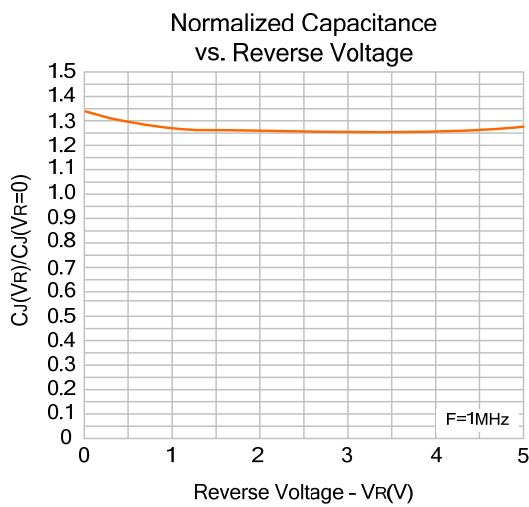
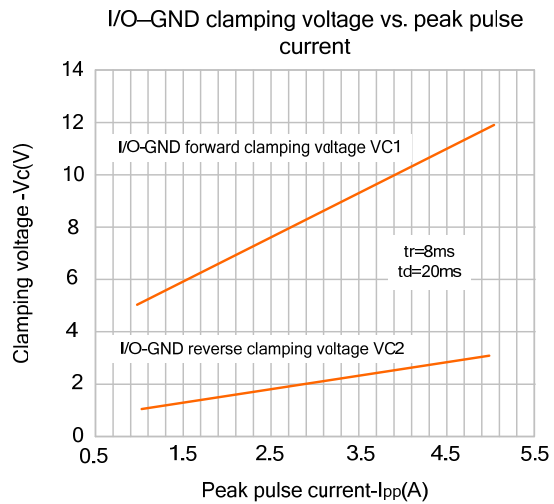
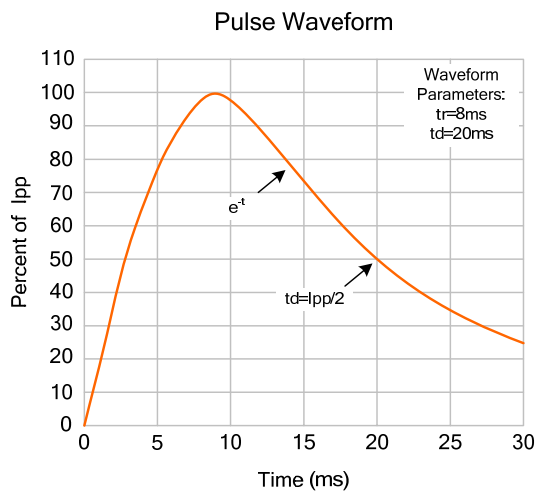
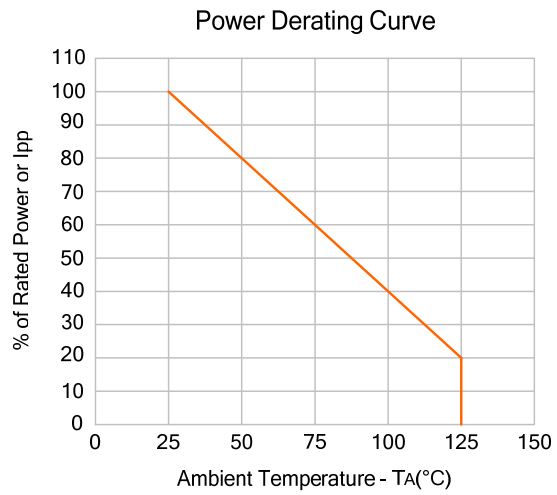
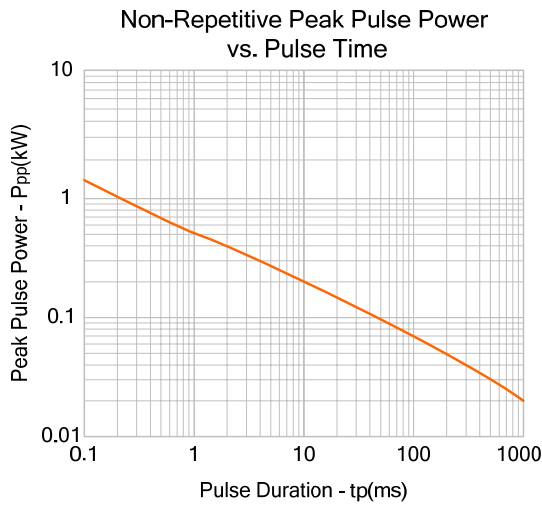
LRC099MC-04AT1G
PIN CONFIGURATION

ABSOLUTE MAXIMUM RATINGS

Characteristics	Symbol	Ratings	Unit
Peak Pulse Power(8/20 μ s)	P _{PP}	150	W
Peak Pulse Current(8/20 μ s)	I _{PP}	5	A
ESD per IEC 61000-4-2(Air)	V _{ESD1}	± 15 kV	kV
ESD per IEC 61000-4-2(Contact)	V _{ESD2}	± 8 kV	kV
Operating Temperature Range	T _{opr}	-55 ~ +125	$^{\circ}$ C
Storage Temperature Range	T _{stg}	-55 ~ +150	$^{\circ}$ C

ELECTRICAL CHARACTERISTICS(T_{amb}=25 $^{\circ}$ C)

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Reverse Working Voltage	V _{RWM}	Any I/O pin to GND			5	V
Reverse Breakdown Voltage	V _{BR}	I _t =1mA; Any I/O pin to GND	6		9	V
Reverse Leakage Current	I _R	V _{RWM} =3V, T=25 $^{\circ}$ C; Any I/O pin to GND			100	nA
Positive Clamping Voltage	V _{C1}	I _{PP} =1A, t _p =8/20ms; Positive pulse; Any I/O pin to GND		8.5	12.0	V
Negative Clamping Voltage	V _{C2}	I _{PP} =1A, t _p =8/20 μ s; Negative pulse; Any I/O pin to GND		1.8		V
Junction Capacitance Between Channel	C _{J1}	V _R =0V, f=1MHz; Between I/O pins			1.0	pF
Junction Capacitance Between I/O And GND	C _{J2}	V _R =0V, f=1MHz; Any I/O pin to GND			1.5	pF

TYPICAL ELECTRICAL CHARACTERISTICS CURVE



TYPICAL ELECTRICAL CHARACTERISTICS CURVE